

5mm Standard T-1 3/4 Type Full Color With Common Anode LED Technical Data Sheet

Part No.: LL-509RGBM2E-004

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 1 OF 10

Approved: ZHOU Checked: Wu Drawn: Shu



Features:

Uniform light output.

Low power consumption.

I.C. Compatible.

Long life-solid state reliability.

The product itself will remain within RoHS compliant Version.

Descriptions:

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

The Pure Green source color devices are made with InGaN on Sapphire substrate Light Emitting Diode.

The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode.

Applications:

TV set.

Monitor.

Telephone.

Computer.

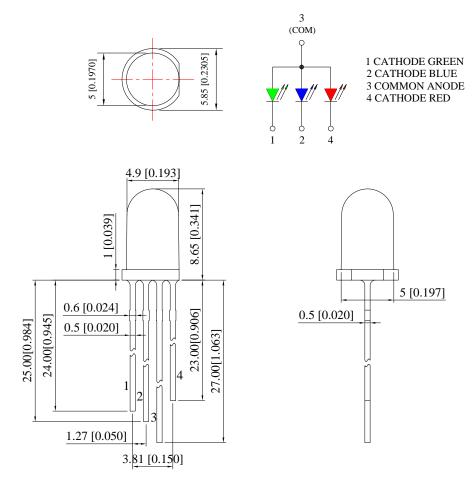
Circuit board, etc.

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 2 OF 10

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Package Dimension:



Part No.	Chip Material	Lens Color	Source Color	
LL-509RGBM2E-004	AlGaInP		Hyper Red	
	InGaN	White Diffused	Pure Green	
	InGaN		Blue	

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25mm (.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.00mm (.039") max.
- 4. Specifications are subject to change without notice.

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 3 OF 10

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Absolute Maximum Ratings at Ta=25

Parameters	Emitting Color	Symbol	Max.	Unit	
	Hyper Red		65		
Power Dissipation	Pure Green	PD	100	mW	
	Blue		100		
Peak Forward Current (1/10 Duty Cycle, 0.1ms P	IFP	100	mA		
Forward Current	Hyper Red	IF	25	mA	
	Pure Green	IF	25	mA	
	Blue	IF	25	mA	
Reverse Voltage		VR	5	V	
Operating Temperature Range		Topr	-40 to +85		
Storage Temperature Range		Tstg	-40 to +100		
Lead Soldering Temperature [4mm (.157") From Body]		Tsld	260 for 5 Seconds		

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 4 OF 10

Approved: ZHOU Checked: Wu Drawn: Shu



Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Emitting Color	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity *		Hyper Red	350	600		mcd	IF=20mA (Note 1)
	IV	Pure Green	450	1000			
		Blue	250	500			
		Hyper Red		60		Deg	IF=20mA (Note 2)
Viewing Angle *	2θ _{1/2}	Pure Green		60			
		Blue		60			
		Hyper Red		632			
Peak Emission Wavelength	λр	Pure Green		520		nm	IF=20mA
		Blue		468			
	λd	Hyper Red		624		nm	IF=20mA (Note 3)
Dominant Wavelength		Pure Green		525			
		Blue		470			
	VF	Hyper Red	1.60	2.20	2.60		
Forward Voltage		Pure Green	2.80	3.50	4.00	V	IF=20mA
		Blue	2.80	3.50	4.00		
Reverse Current		Hyper Red			10		
	IR	Pure Green			10	μΑ	$V_R=5V$
		Blue			10		

Notes:

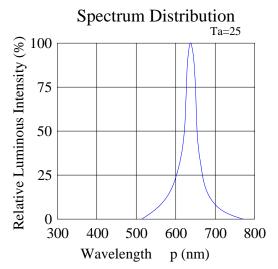
- 1. Luminous Intensity Measurement allowance is \pm 10%.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
 - 3. The dominant wavelength (λd) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 5 OF 10

Approved: ZHOU Checked: Wu Drawn: Shu

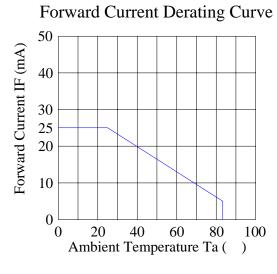


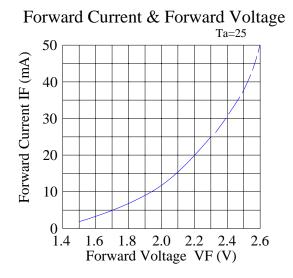
Typical Electrical / Optical Characteristics Curves (25 Ambient Temperature Unless Otherwise Noted) Hyper Red:

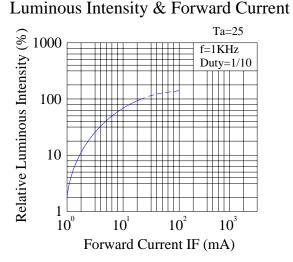


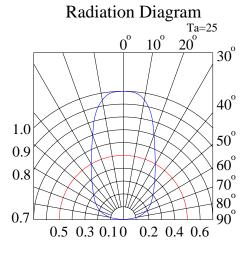
Ambient Temperature

Note The Property of the







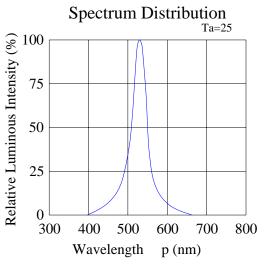


Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 6 OF 10

Approved: ZHOU Checked: Wu Drawn: Shu



Pure Green:



Ambient Temperature

Ambient Temperature

100

100

100

100

100

100

Ambient Temperature

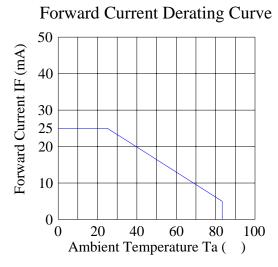
100

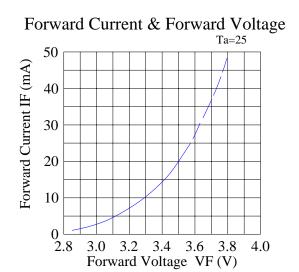
100

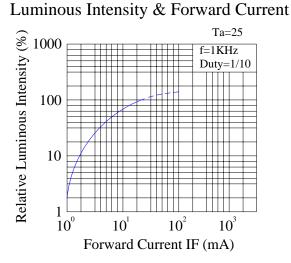
Ambient Temperature

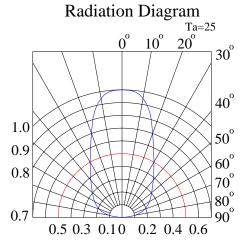
100

Ambient Temperature Ta ()







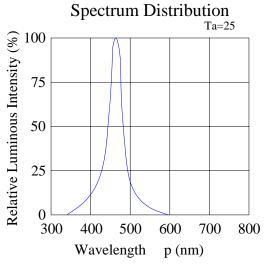


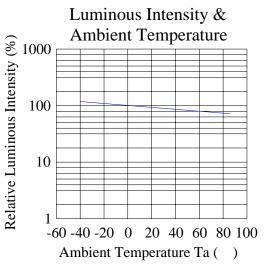
Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 7 OF 10

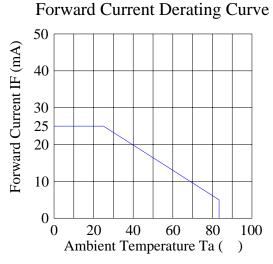
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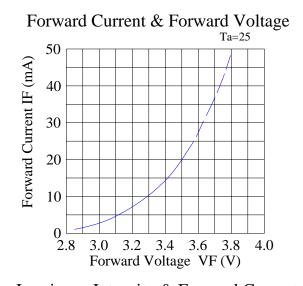


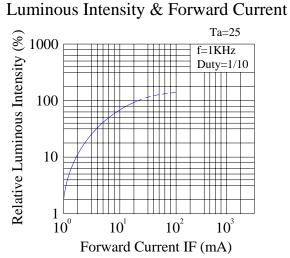
Blue:

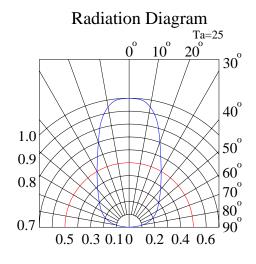












Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 8 OF 10

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Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1) Test Items and Results:

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat	JEITA ED-4701 300 302	Tsld=260±5 , 10sec 3mm from the base of the epoxy bulb	1 time	0/100
Solder ability	JEITA ED-4701 300 303	Tsld=235±5 , 5sec (using flux)	1time over 95%	0/100
Thermal Shock	JEITA ED-4701 300 307	0 ~100 15sec, 15sec	100 cycles	0/100
Temperature Cycle	JEITA ED-4701 100 105	-40 ~25 ~100 ~25 30min,5min,30min,5min	100 cycles	0/100
Moisture Resistance Cycle	JEITA ED-4701 200 203	25 ~65 ~-10 90%RH 24hrs/1cycle	10 cycles	0/100
High Temperature Storage	JEITA ED-4701 200 201	Ta=100	1000hrs	0/100
Terminal Strength (Pull test)	JEITA ED-4701 400 401	Load 10N (1kgf) 10±1sec	No noticeable damage	0/100
Terminal Strength (bending test)	JEITA ED-4701 400 401	Load 5N (0.5kgf) 0°~90°~0° bend 2 times	No noticeable damage	0/100
Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=60 , RH=90%	1000hrs	0/100
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40	1000hrs	0/100
Steady State Operating Life		Ta=25 , IF=30mA	1000hrs	0/100
Steady State Operating Life of High Humidity Heat		Ta=60 , RH=90%, IF=30mA	500hrs	0/100
Steady State Operating Life of Low Temperature		Ta=-30 , IF=20mA	1000hrs	0/100

2) Criteria for Judging the Damage:

Itom	Item Symbol Test Conditions	Tost Conditions	Criteria for Judgment		
Item		rest Conditions	Min	Max	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

*) F.V.: First Value.

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 9 OF 10

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Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30 or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

3. Soldering Condition

- 3.1 Pb-free solder temperature profile
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260 for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.

Spec No.: B508 X360 Rev No.: V.2 Date: Oct./12/2005 Page: 10 OF 10

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